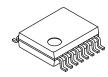
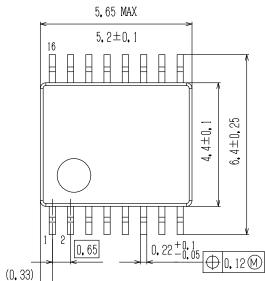
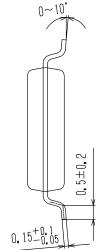
**DATE 23 OCT 2013** 

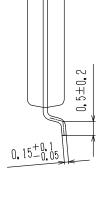


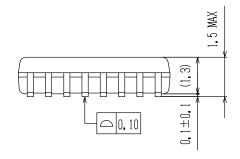


## SSOP16 (225mil) CASE 565AM **ISSUE A**

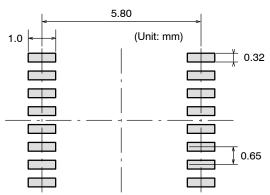








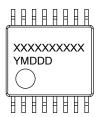
## **SOLDERING FOOTPRINT\***



NOTE: The measurements are not to guarantee but for reference only.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code

Y = Year

M = Month

DDD = Additional Traceability Data

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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PAGE 2 OF 2

ISSUE	REVISION	DATE	
0	RELEASED FOR PRODUCTION FROM SANYO ENACT# S-010 TO ON SEMICONDUCTOR. REQ. BY D. TRUHITTE.	30 JAN 2012	
А	ADDED MARKING AND SOLDER FOOTPRINT INFORMATION. REQ. BY D. TRUHITTE.	23 OCT 2013	

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